TRANSMITTAL FORM

I hereby certify that this correspondence is being deposited with the United States Postal Service as "Express Mail" under Label No. EV 303 952 525 US in an envelope addressed to: Mail Stop: Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on:

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Mail Stop: Patent Application Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Attorney Doc. #: _ Mailing Date:

Dear Sir:

Transmitted herewith for filing is the patent application of:

Inventor(s):

Jiaw-Ren Shin

Jian-Hsing Lee

Shui-Hung Chen

For:

Deep Well Implant Structure Providing Latch-Up Resistant **CMOS Semiconductor Product**

Submitted herewith are:

- sheet(s) of formal drawings
- An Assignment of the invention to Taiwan Semiconductor Manufacturing Co., Ltd.., together with Assignment Recordal Sheet
- A Declaration for patent application under CFR 1.63 and 1.68

The filing fee has been calculated as shown below:

	No. Filed	No. Extra	Small Entity Fee	Large Entity Fee	Total
Basic Fee	-		\$385.00	\$770.00	\$770.00
Total Claims	20x20	0 x	\$9.00	\$18.00	\$0
Indep. Claims	4-3	1 x	\$43.00	\$86.00	\$86.00
Multiple Dep. Clms.			\$145.00	\$290.00	\$0
Assign. Rec. Fee	-		\$40.00	\$40.00	\$40.00
TOTAL					\$896.00

Mailing Date: <u>190-20, 2004</u>
Attorney Docket No.: <u>17, 200-1/94</u>

X	Attached is a Credit Card Payment Form for the sum of \$	896°
	A duplicate copy of this transmittal is attached.	

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Visa Credit Card No. 4756 8461 9568 0263. A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 CFR 1.6
Any patent application processing fees under 37 CFR 1.17

Respectfully submitted,

TUNG & ASSOCIATES

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RWT/kd **Enclosures**